



# ACE3926E

## Dual N-Channel 20-V MOSFET

### Description

The ACE3926E utilize a high cell density trench process to provide low  $r_{DS(on)}$  and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

### Features

- Low  $r_{DS(on)}$  trench technology
- Low thermal impedance
- Fast switching speed

### Applications

- Power Routing
- Li Ion Battery Packs
- Level Shifting and Driver Circuits

### Absolute Maximum Ratings

Parameter		Symbol	Limit	Units
Drain-Source Voltage		$V_{DS}$	20	V
Gate-Source Voltage		$V_{GS}$	$\pm 12$	V
Continuous Drain Current <sup>a</sup>	$T_A=25^\circ\text{C}$	$I_D$	13	A
	$T_A=70^\circ\text{C}$		10	
Pulsed Drain Current <sup>b</sup>		$I_{DM}$	50	A
Continuous Source Current (Diode Conduction) <sup>a</sup>		$I_S$	7	A
Power Dissipation <sup>a</sup>	$T_A=25^\circ\text{C}$	$P_D$	2.5	W
	$T_A=70^\circ\text{C}$		1.5	
Operating temperature / storage temperature		$T_J/T_{STG}$	-55~150	$^\circ\text{C}$

### THERMAL RESISTANCE RATINGS

Parameter		Symbol	Maximum	Units
Maximum Junction-to-Ambient <sup>a</sup>	$t \leq 10 \text{ sec}$	$R_{\theta JA}$	83	$^\circ\text{C/W}$
	Steady State		120	

### Notes

a. Surface Mounted on 1" x 1" FR4 Board.

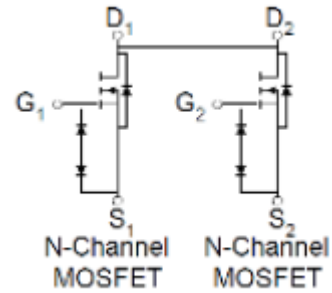
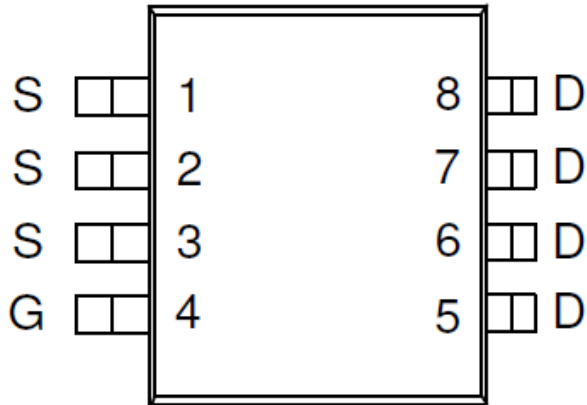
b. Pulse width limited by maximum junction temperature



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**Packaging Type**  
DFN3\*3-8L



### Ordering information

ACE3926E NN + H

- └─ Halogen - free
- └─ Pb - free
- └─ NN : DFN3\*3-8L



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### Electrical Characteristics

T<sub>A</sub>=25°C, unless otherwise specified.

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static						
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	0.4			V
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±12 V			±10	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 16 V, V <sub>GS</sub> = 0 V			1	μA
		V <sub>DS</sub> = 16V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55°C			10	
On-State Drain Current <sup>A</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 4.5 V	20			A
Drain-Source On-Resistance <sup>A</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 2 A			10	mΩ
		V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 1.6 A			14	
Forward Transconductance <sup>A</sup>	g <sub>FS</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 2 A		3		S
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> = 3.5 A, V <sub>GS</sub> = 0 V		0.8		V
Dynamic <sup>b</sup>						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 2 A		15		nC
Gate-Source Charge	Q <sub>gs</sub>			1.9		
Gate-Drain Charge	Q <sub>gd</sub>			3.7		
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>DS</sub> = 10 V, R <sub>L</sub> = 5 Ω, I <sub>D</sub> = 2 A, V <sub>GEN</sub> = 4.5 V, R <sub>GEN</sub> = 6 Ω,		178		ns
Rise Time	t <sub>r</sub>			332		
Turn-Off Delay Time	t <sub>d(off)</sub>			1939		
Fall Time	t <sub>f</sub>			902		
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 Mhz		1225		pF
Output Capacitance	C <sub>oss</sub>			151		
Reverse Transfer Capacitance	C <sub>rss</sub>			123		

Note :

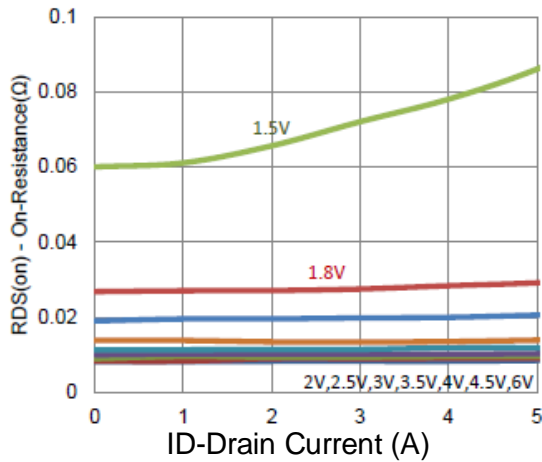
- Pulse test: PW ≤ 300μs duty cycle ≤ 2%.
- Guaranteed by design, not subject to production testing



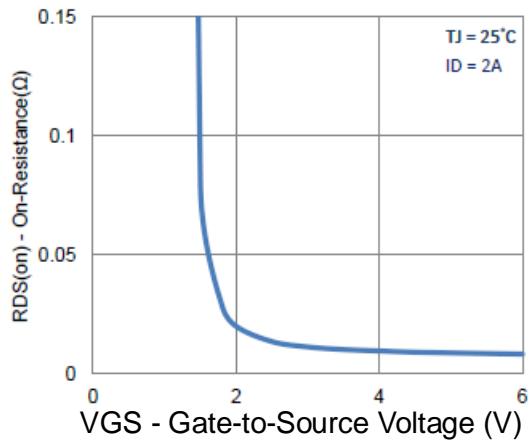
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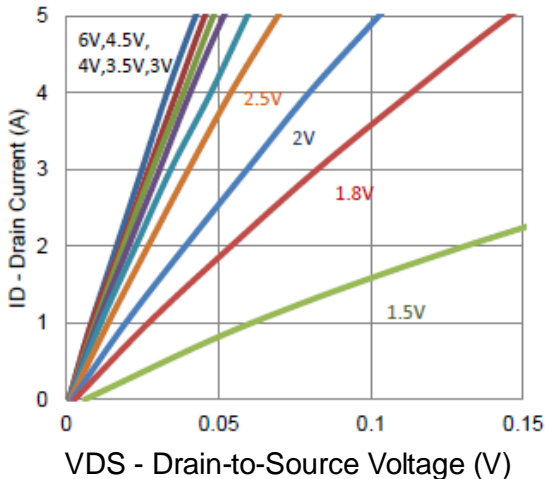
### Typical Performance Characteristics



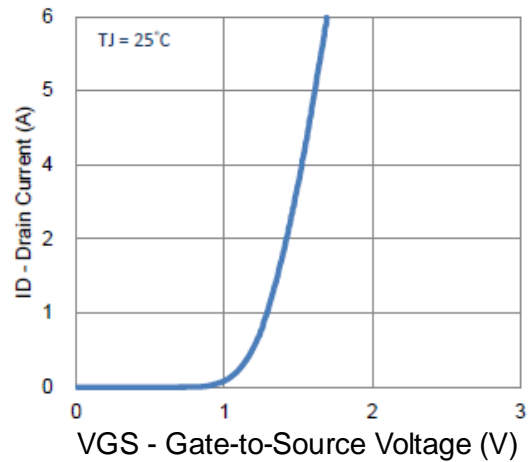
1. On-Resistance vs. Drain Current



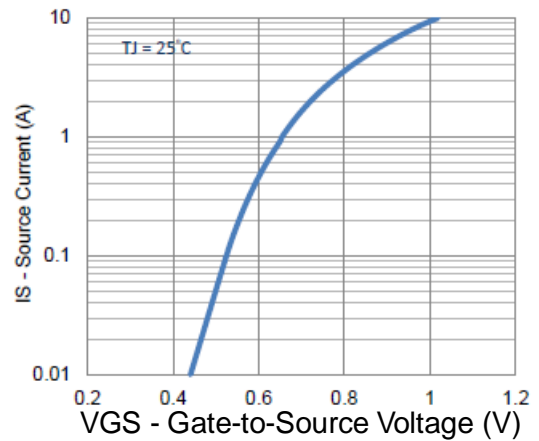
3. On-Resistance vs. Gate-to-Source Voltage



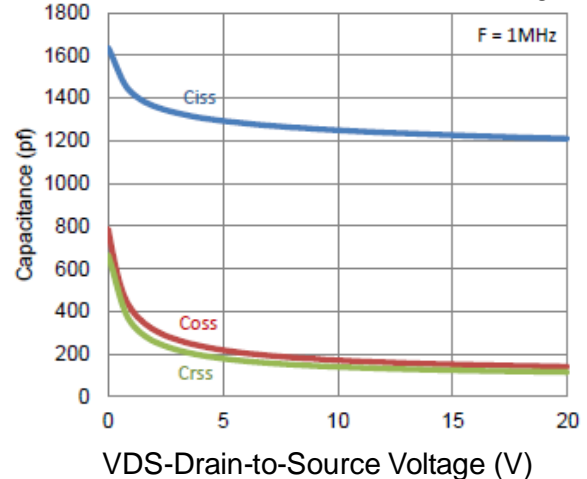
5. Output Characteristics



2. Transfer Characteristics



4. Drain-to-Source Forward Voltage



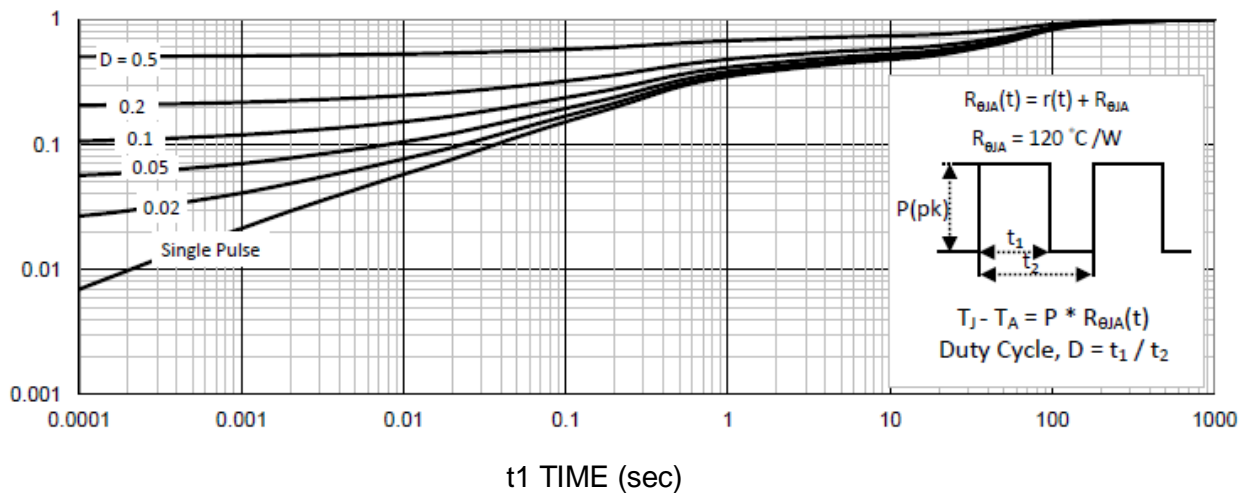
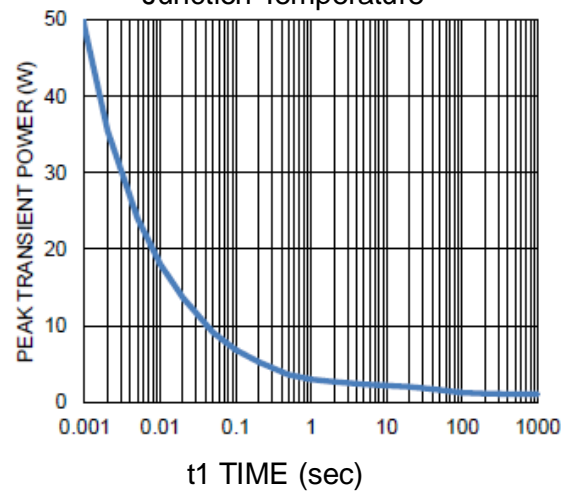
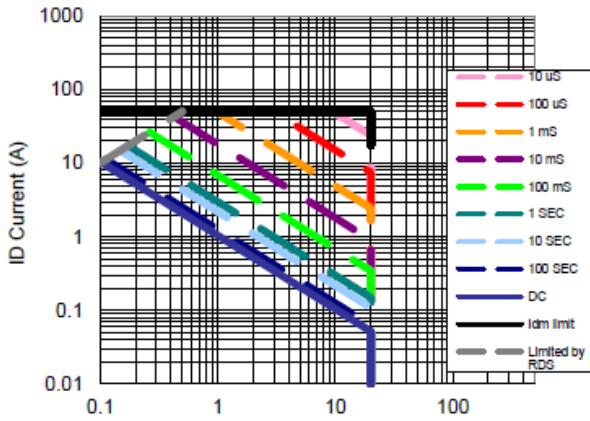
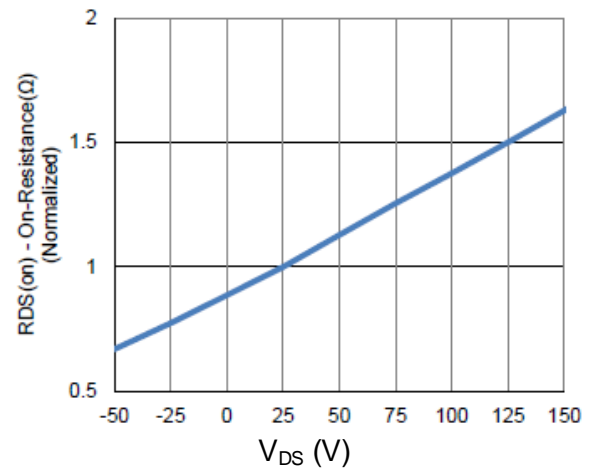
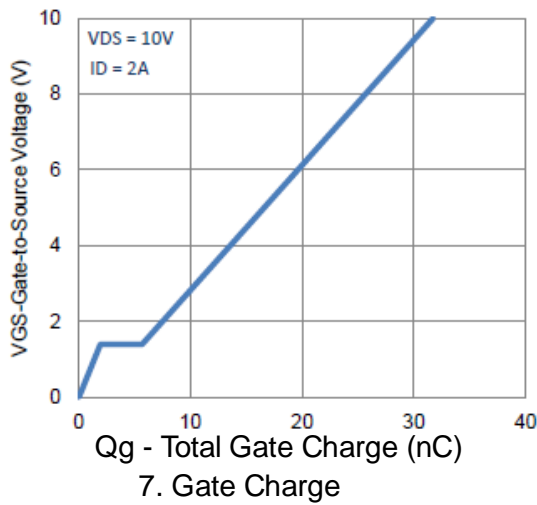
6. Capacitance



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## Dual N-Channel 20-V MOSFET

### Typical Performance Characteristics



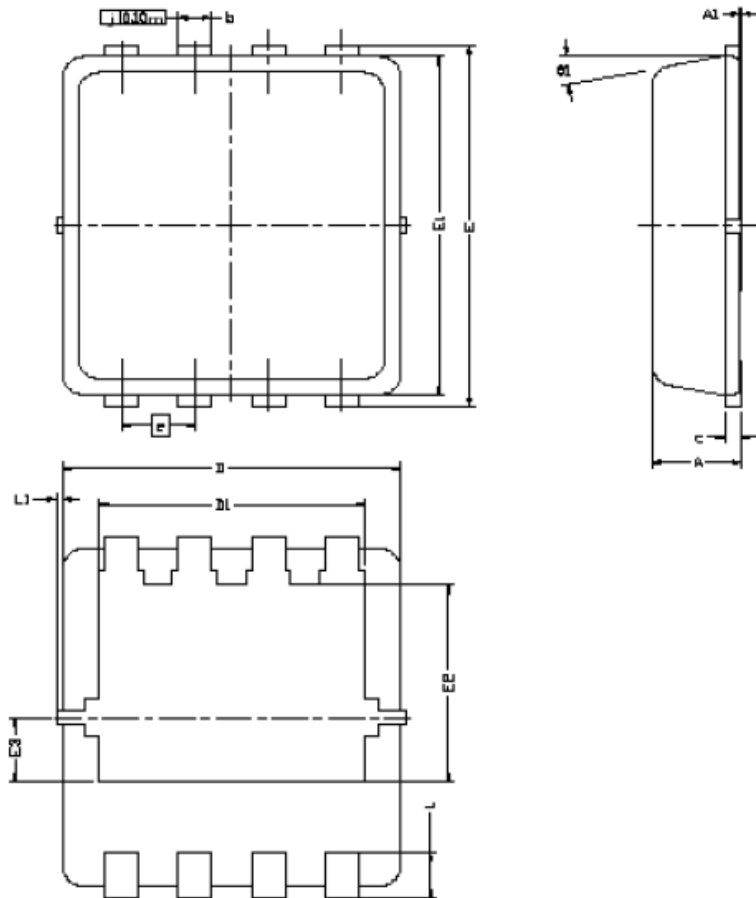


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### Packing Information

DFN3\*3-8L



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.700	0.80	0.900	0.0276	0.0315	0.0354
A1	0.00		0.05	0.000		0.002
b	0.24	0.30	0.35	0.009	0.012	0.014
c	0.08	0.152	0.25	0.003	0.006	0.010
D	2.90BSC			0.114BSC		
E	2.80BSC			0.110BSC		
E1	2.30BSC			0.091BSC		
e	0.65BSC			0.026BSC		
L	0.20	0.375	0.450	0.008	0.0148	0.0177
L1	0		0.100	0		0.004
Ø1	0	10	12	0	10	12

Unit: mm



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### Notes

ACE does not assume any responsibility for use as critical components in life support devices or systems without the express written approval of the president and general counsel of ACE Electronics Co., LTD.

As sued herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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